

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of :
Akihisa HONGO et al. :
Serial No. NEW : **Attn: APPLICATION BRANCH**
Filed February 18, 2004 : Attorney Docket No. 2004_0222

ELECTROLESS PLATING APPARATUS
AND METHOD
**(Rule 1.53(b) Divisional
of Serial No. 09/983,399,
Filed October 24, 2001)**

THE COMMISSIONER IS AUTHORIZED
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CLAIM OF PRIORITY UNDER 35 USC 119

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450


Sir:

Applicants in the above-entitled application hereby claim the date of priority under the International Convention of Japanese Patent Application No. 2000-327800, filed October 26, 2000, and Japanese Patent Application No. 2000-376189, filed December 11, 2000, as acknowledged in the Declaration of this application.

Certified copies of said Japanese Patent Applications are of record in parent application Serial No. 09/983,399, filed October 24, 2001.

Respectfully submitted,

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